## Nch 60V 2A Middle Power MOSFET

V <sub>DSS</sub>	60V
R <sub>DS(on)</sub> (Max.)	240mΩ
I <sub>D</sub>	±2A
P <sub>D</sub>	0.5W

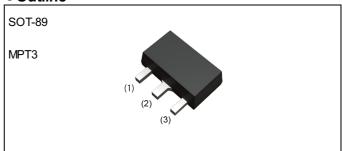
# ● Features

- 1) Low on-resistance
- 2) Low voltage drive(2.5V drive)
- 3) AEC-Q101 Qualified

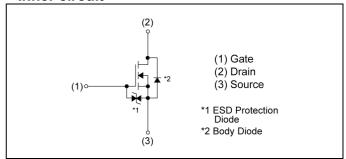
## Application

Switching

### Outline



## ●Inner circuit



Packaging specifications

- r doktaging opcomoducito					
	Packing	Embossed Tape			
	Reel size (mm)	180			
Туре	Tape width (mm)	12			
	Quantity (pcs)	1000			
	Taping code	T100			
	Marking	LH			

## ● **Absolute maximum ratings** (T<sub>a</sub> = 25°C ,unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain - Source voltage	V <sub>DSS</sub>	60	V
Continuous drain current	I <sub>D</sub>	±2	Α
Pulsed drain current	I <sub>DP</sub> *1	±8	Α
Gate - Source voltage	V <sub>GSS</sub>	±12	V
Dower dissination	P <sub>D</sub> *2	0.5	W
Power dissipation	P <sub>D</sub> *3	2	W
Junction temperature	T <sub>j</sub>	150	°C
Operating junction and storage temperature range	T <sub>stg</sub>	-55 to +150	°C

## ●Thermal resistance

Doromotor	Cumbal	Values			Linit
Parameter	Symbol	Min.	Тур.	Max.	Unit
The word reciptores is motion, ambient	R <sub>thJA</sub>	-	-	250	°C/W
Thermal resistance, junction - ambient	R <sub>thJA</sub> *3	-	-	62.5	°C/W

## ● Electrical characteristics (T<sub>a</sub> = 25°C)

Doromotor	Cymah al	Symbol Conditions		Values			
Parameter	Symbol Conditions -		Min.	Тур.	Max.	Unit	
Drain - Source breakdown voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0V$ , $I_D = 1mA$	60	-	-	V	
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_{j}}$	I <sub>D</sub> = 1mA referenced to 25°C	-	63.3	-	mV/°C	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 60V, V <sub>GS</sub> = 0V	1	-	1	μΑ	
Gate - Source leakage current	I <sub>GSS</sub>	$V_{GS} = \pm 12V, V_{DS} = 0V$	1	-	±10	μA	
Gate threshold voltage	$V_{GS(th)}$	V <sub>DS</sub> = 10V, I <sub>D</sub> = 1mA	0.8	-	1.5	V	
Gate threshold voltage temperature coefficient	$\frac{\Delta  V_{GS(th)}}{\Delta  T_j}$	I <sub>D</sub> = 1mA referenced to 25°C	-	-2.72	-	mV/°C	
		V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 2A	-	190	240		
Static drain - source on - state resistance	R <sub>DS(on)</sub> *4	V <sub>GS</sub> = 4.0V, I <sub>D</sub> = 2A	-	195	250	mΩ	
on state registaries		V <sub>GS</sub> = 2.5V, I <sub>D</sub> = 2A	-	280	335		
Forward Transfer Admittance	Y <sub>fs</sub>  *4	V <sub>DS</sub> = 10V, I <sub>D</sub> = 2A	1.5	-	-	S	

<sup>\*1</sup> Pw≦10µs , Duty cycle≦1 %

<sup>\*2</sup> Each terminal mounted on a reference land.

<sup>\*3</sup> Mounted on a ceramic board (40x40x0.7mm)

<sup>\*4</sup> Pulsed

# ●Electrical characteristics (T<sub>a</sub> = 25°C)

Darameter	Cumphal	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0V	-	160	-	
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 10V	-	50	-	pF
Reverse transfer capacitance	C <sub>rss</sub>	f = 1MHz	-	45	-	
Turn - on delay time	t <sub>d(on)</sub> *4	$V_{DD} \simeq 30V, V_{GS} = 4V$	-	8	-	
Rise time	t <sub>r</sub> *4	I <sub>D</sub> = 1A	-	18	-	no
Turn - off delay time	t <sub>d(off)</sub> *4	$R_L \simeq 30\Omega$	-	40	-	ns
Fall time	t <sub>f</sub> *4	$R_G = 10\Omega$	-	20	-	

## • Gate charge characteristics $(T_a = 25^{\circ}C)$

	\ a	,				
Downwater Cymhal		Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
Total gate charge	Qg*4	V <sub>DD</sub> ≃ 30V.	-	5.0	-	
Gate - Source charge	Q <sub>gs</sub> *4	$V_{DD} \approx 30V$ , $I_{D} = 2A$ , $V_{GS} = 4V$	-	1.0	-	nC
Gate - Drain charge	Q <sub>gd</sub> *4	$V_{GS} = 4V$	-	2.5	-	

## ●Body diode electrical characteristics (Source-Drain) (T<sub>a</sub> = 25°C)

Darameter	Symbol	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
Continuous forward current	Is	T = 25°C	-	-	2	Α
Pulse forward current	I <sub>SP</sub> *1	T <sub>a</sub> = 25°C	-	-	8	Α
Forward voltage	V <sub>SD</sub> *4	V <sub>GS</sub> = 0V, I <sub>S</sub> = 2A	-	-	1.2	V

Fig.1 Power Dissipation Derating Curve

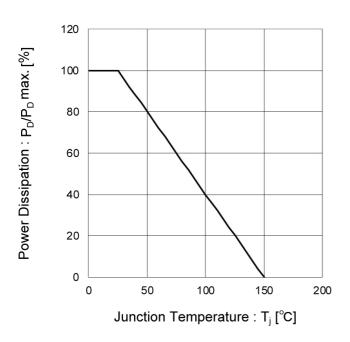
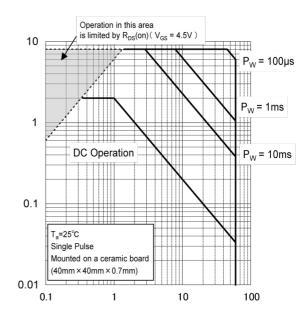


Fig.2 Maximum Safe Operating Area



Drain Current : I<sub>D</sub> [A]

Drain - Source Voltage: V<sub>DS</sub>[V]

Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

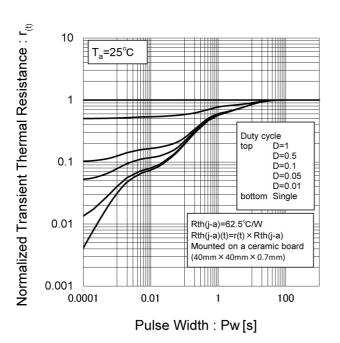
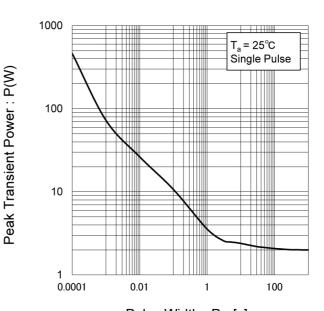


Fig.4 Single Pulse Maximum Power dissipation

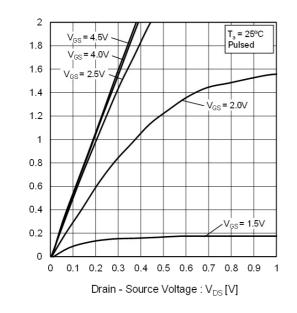


Pulse Width : Pw [s]

Drain Current: I<sub>D</sub> [A]

### • Electrical characteristic curves

Fig.5 Typical Output Characteristics(I)



Drain Current : I<sub>D</sub> [A]

Fig.6 Typical Output Characteristics(II)

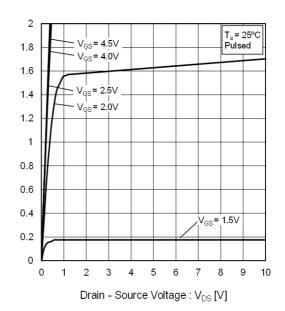


Fig.7 Breakdown Voltage vs.
Junction Temperature

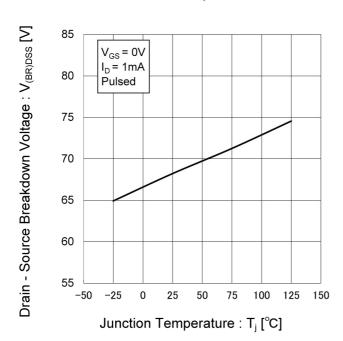


Fig.8 Typical Transfer Characteristics

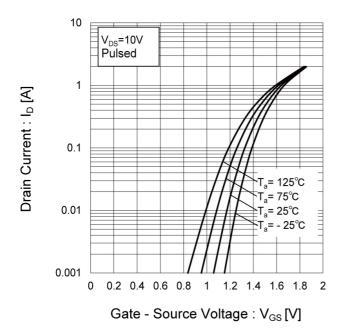


Fig.9 Gate Threshold Voltage vs.
Junction Temperature

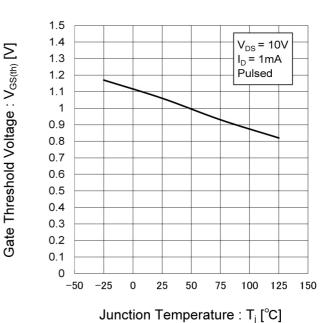


Fig.10 Forward Transfer Admittance vs.
Drain Current

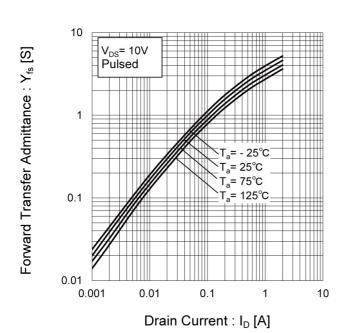


Fig.11 Drain Current Derating Curve

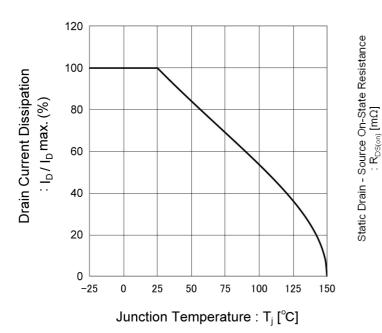


Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage

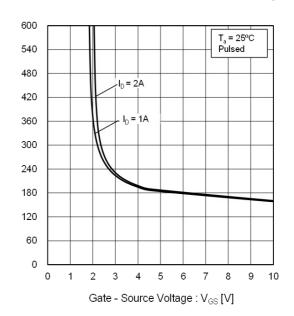
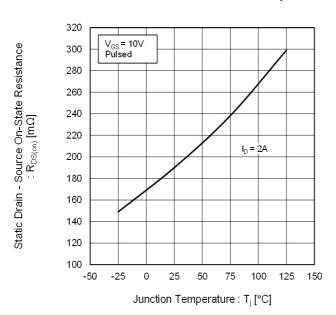


Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature



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Fig.14 Static Drain - Source On - State
Resistance vs. Drain Current (I)

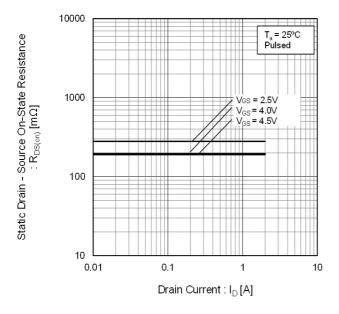


Fig.15 Static Drain - Source On - State Resistance vs. Drain Current (II)

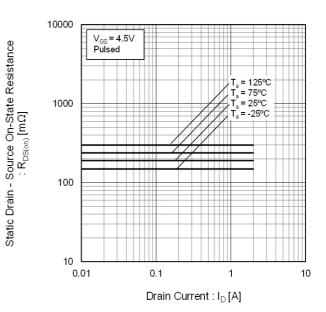


Fig.16 Static Drain - Source On - State Resistance vs. Drain Current (III)

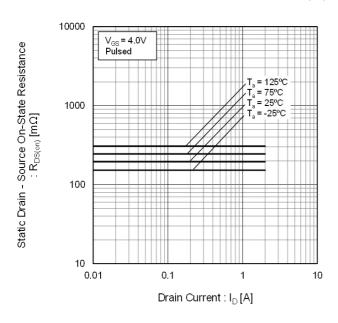


Fig.17 Static Drain - Source On - State Resistance vs. Drain Current (IV)

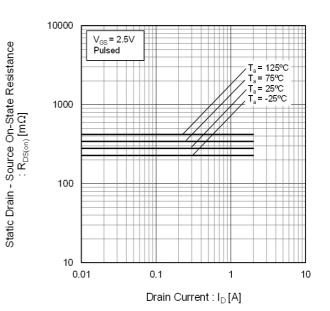


Fig.18 Typical Capacitance vs.

Drain - Source Voltage

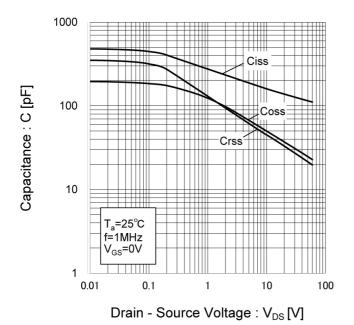


Fig.19 Switching Characteristics

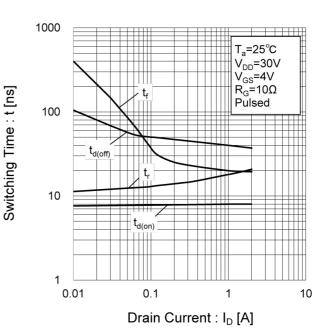


Fig.20 Dynamic Input Characteristics

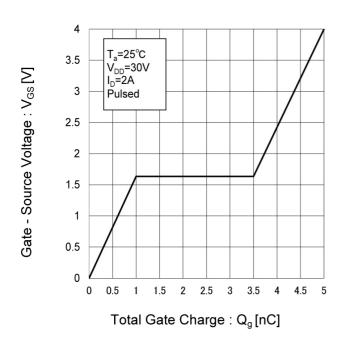
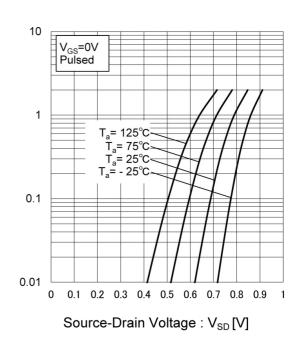


Fig.21 Source Current vs.

Source Drain Voltage



Source Current : Is [A]

## Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

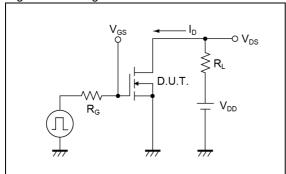


Fig.2-1 Gate Charge Measurement Circuit

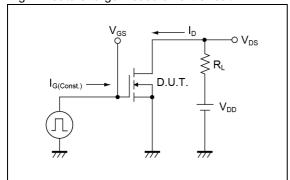


Fig.1-2 Switching Waveforms

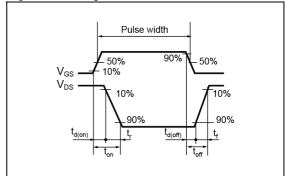
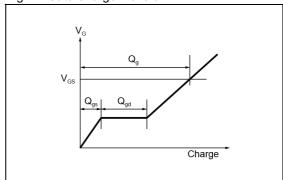
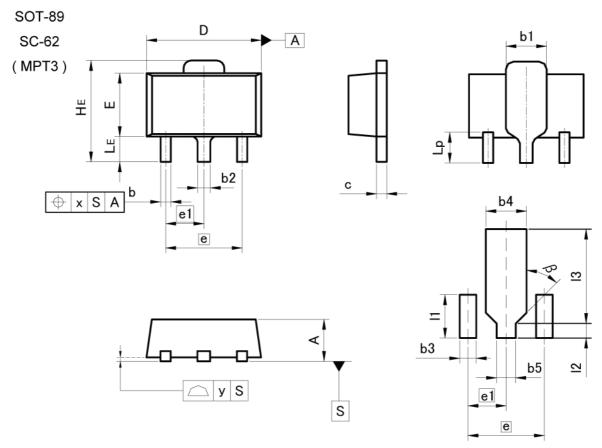


Fig.2-2 Gate Charge Waveform





## Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	1.40	1.60	0.055	0.063
b	0.30	0.50	0.012	0.020
b1	1.50	1.70	0.059	0.067
b2	0.40	0.60	0.016	0.024
С	0.35	0.50	0.014	0.020
D	4.40	4.70	0.173	0.185
E	2.40	2.70	0.094	0.106
е	3.	00	0.1	18
e1	1.	1.50		159
HE	3.70	4.30	0.146	0.169
LE	0.80	1.20	0.031	0.047
Lp	1.01	1.41	0.040	0.056
х		0.15	-:	0.006
У	-	0.10	-	0.004

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
b3	-	0.65	-	0.026
b4	_	1.70	_	0.067
b5	<del>-</del> >	0.75	-	0.030
l1	-1	1.71	_	0.067
12	-/	0.58		0.023
13	20	3.72	_	0.146
β	45°		45	0

Dimension in mm/inches



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(Note1) Medical Equipment Classification of the Specific Applications

ſ	JÁPAN USA		EU	CHINA
Ī	CLASSⅢ	CL ACCIII	CLASS II b	СГУССШ
ſ	CLASSIV	CLASSⅢ	CLASSⅢ	CLASSⅢ

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  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

#### **Precautions Regarding Application Examples and External Circuits**

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### **Precaution for Storage / Transportation**

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
  may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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